

Model	No.:
Date	/ Rev

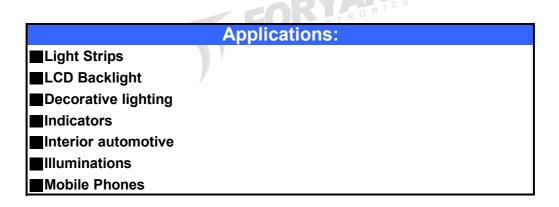
FYLS-2835KUYC-0.2W 2023.05.05 / A

# **PRODUCT SPECIFICATION**

Model No.: FYLS-2835KUYC-0.2W

# Features:

SMD Type
Size (mm):3.50*2.80*0.68
Emitting Color: Yellow.
Lens Color: Yellow Diffused.
SMT package
Suitable for all SMT assembly and soldering method
Pb-free Reflow soldering application
RoHS Compliant
MSL:6





CUSTOMER APPROVED SIGNATURES	APPROVED BY	SALES BY	PREPARED BY
		Foryard S020 2023. 05. 05	Foryard E001 3033. 05. 05

# NINGBO FORYARD OPTOELECTRONICS CO., LTD.

Add:No. 666 Jinghua Road, Hi-tech Park, Ningbo, Zhejiang, China Tel: 0086-574-87933652 87927870 Fax: 0086-574-87927917 E-mail:Sales@foryard.com (General)

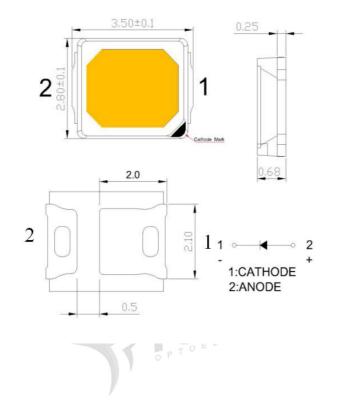
<u>Http://www.foryard.com</u>

**Zip:**315103

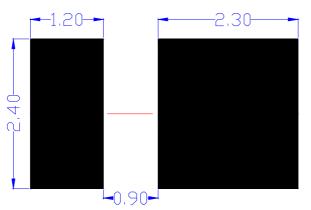


Model No.:	FYLS-2835KUYC-0.2W
Date / Rev.	2023.05.05 / A

## Mechanical Dimensions



Recommend Soldering pad design(unit=mm)



Notes:

1. Dimension in millimeter, tolerance is  $\pm 0.10$ .

2.Angle:±5°

3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The drawing is different from the actual one, please refer to the sample.



Model No.:	FYLS-2835KUYC-0.2W
Date / Rev.	2023.05.05 / A

## ■ Absolute Maximun Ratings(Ta=25°C)

Parameter	Symbol	MAX.	Unit
Power Dissipation	PD	200	mW
Peak Forward Current*	IFP	100	mA
Continuous Forward Current	IF	60	mA
Reverse Voltage	VR	5	V
Junction Temperature	TJ	85	°C
Electrostatic Discharge(HBM)	ESD	2000	V
Operating Temperature Range	Topr	-30~ +85	°C
Storage Temperature Range	Tstg	-30~ +100	°C

\*1/10 Duty Cycle, 0.1ms Pulse Width

## ■ Typical Electrical &Optical Charcteristics(Ta=25°C)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V <sub>F</sub>	IF=60mA	2.8	3	3.4	V
Reverse Current	I <sub>R</sub>	VR=5V	<b>—</b>		10	μA
Dominant Wavelength	λD	IF=60mA	585		595	nm
Luminous Flux	Φ	IF=60mA	14	20		Lm
Color Rendering Index	Ra	0 <sup>E</sup> IF=60mA	70			
Viewing Angle	2θ <sub>1/2</sub>	IF=60mA		120		Deg
Material	Į.					

#### Material

Item	Reflector	Wire	Encapsulate	Chip
Material	PPA	Gold	Silicone	InGaN/GaN

Note:

1.Luminous Intensity is based on the Foryard standards.

2.Pay attention about static for InGaN

#### The Luminous Flux Grade of Products(Unit: Lm) ;Test Condition: IF=60mA,Ta=25°C

Code	L1	L3	L5
Luminous Flux (Lm)	14~16	16~18	18~20

Tolerance of measurement of luminous intensity is ±15%

Forward Voltage Grade of Products (Unit: V); Test Condition. IF=60mA,Ta=25°C

Code	V7	V8	V9	V10	V11	V12
Forward Voltage(V)	2.8~2.9	2.9~3.0	3.0~3.1	3.1~3.2	3.2~3.3	3.3~3.4

Tolerance of measurement of forward voltage is ±0.1V

Dominate Wavelength Grade of Products (Unit: nm); Test Condition : IF=60mA,Ta=25°C

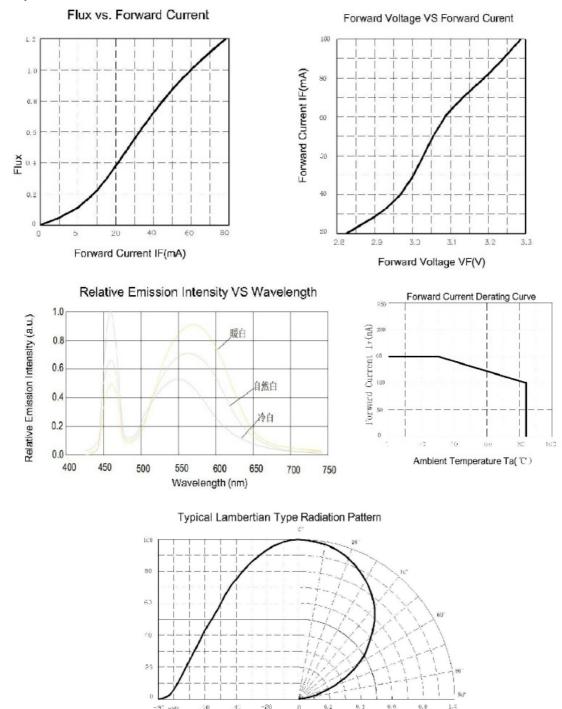
Code	UY1	UY2
Dominate Wavelength(nm)	585~590	590~595

Tolerance for each Dominate Wavelength bin is ±1nm



Model No.:	FYLS-2835KUYC-0.2W
Date / Rev.	2023.05.05 / A





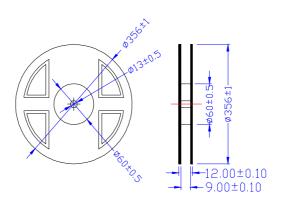
NOTE:25°C free air temperature unless otherwise specified



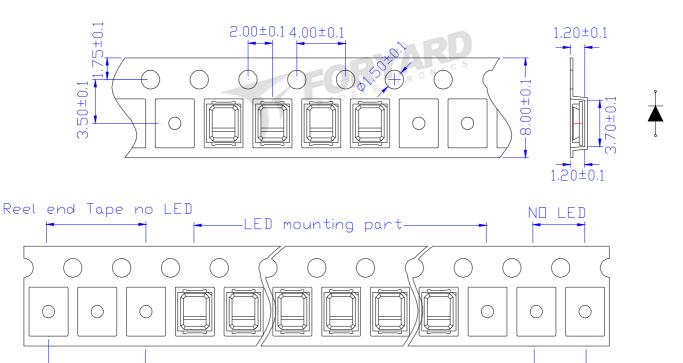
Model No.:	FYLS-2835KUYC-0.2W
Date / Rev.	2023.05.05 / A

## Package-

1. Reel Dimension



## 2. Tape Dimension



## Notice:

1. Tolerance unless mentioned is  $\pm$ 0.2mm

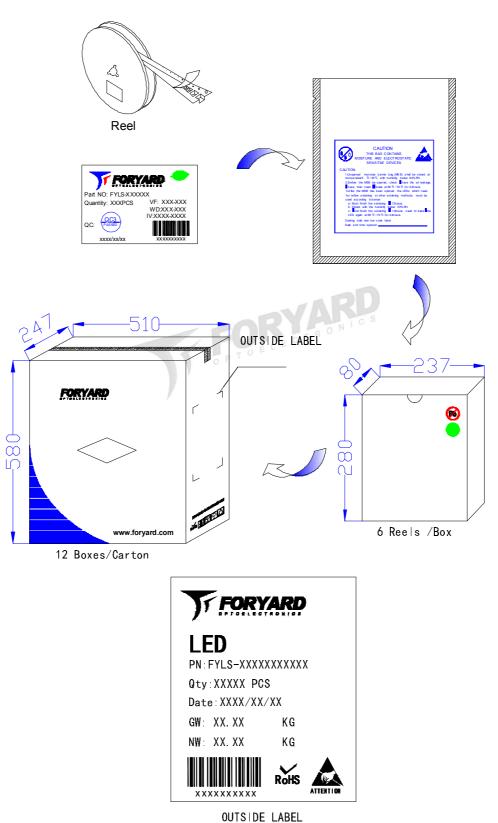
Reel Lend Min 200mm

Reel Lend Min 200mm



Model No.:	FYLS-2835KUYC-0.2W
Date / Rev.	2023.05.05 / A

3.Packing Diagram



## Notice:

1.Quantity:16000 PCS/Reel

2. The specifications are subject to change without notice. Please contact us for updated information.

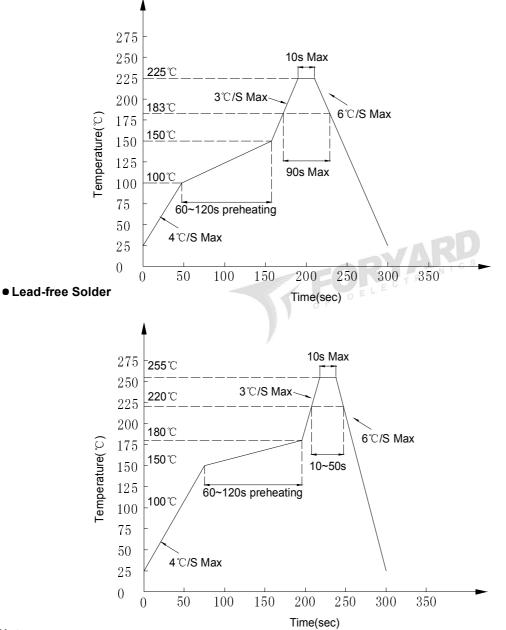


Model No.:	FYLS-2835KUYC-0.2W
Date / Rev.	2023.05.05 / A

#### Soldering Characteristics-

### Reflow Soldering

Lead Solder



#### Notes:

1.Although the recommended soldering conditions are specified in above table, reflow or hand soldering at the lowest possible temperature is desired for the LEDs.

2.A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

3.All temperatures refer to solder Pad.

### Hand Soldering

Soldering temperature	300℃ Max. (25W Max.)	One time olny
Soldering time	5 ±1sec	One time only



Model No.:	FYLS-2835KUYC-0.2W	
Date / Rev.	2023.05.05 / A	

#### Handling of Silicone Resin LEDs-

#### Handling Indications

When handling the product, do not touch it directly with bare hands as it may contaminate the surface and affect on optica characteristics. In the worst cases, excessive force to the product might result in catastrophic failure due to package damage and/or wire breakage.



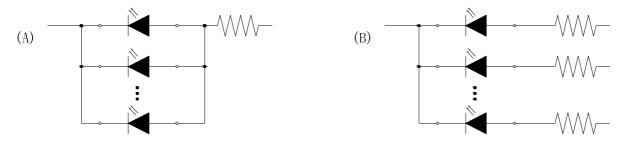
When handling the product with tweezers,LEDs should only be handled from the side and make sure that excessive force is not applied to the resin portion of the pordct. Failure to comply can cause the resin portion of the product to be cut,chipped,delaminated and/or deformed, and wire to be broken, and thus resulting in catastrophic failure.





#### Recommended circuit-

• In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LEC It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LE with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage(VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.



• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product; such operation can cause migration resulting in LED damage.

#### Storage-

Storage Conditions

1.Unopened moisture barrier bag (MBB) shall be stored at temperature below  $5^{\circ}C \sim 30^{\circ}C$ , with humidity below  $60^{\circ}RH$ . 2.Before the MBB be opened, check if have the air leakage, if have, then need to bake at  $65^{\circ}C \sim 70^{\circ}C$  for 24hours.

- 3.After the MBB has been opened, the LEDs which need for reflow soldering or other soldering methods, must be used according to below:
  - a: Must finish the soldering in 12hours
  - b: Stored with the humidity below 30%RH
  - c: If not finish the soldering in 12hours, need to bake the LED again at  $65\,^\circ\!C$  ~70 $^\circ\!C$  for 24hours